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Octal D-type Flip-Flops (with 3-state outputs)
Octal D-type Flip-Flops (with inverted 3-state outputs)



ADE-205-499 (Z) 1st. Edition Sep. 2000

#### **Description**

These devices are positive edge triggered flip-flops. The difference between HD74HC374 and HD74HC534 is only that the former is a true outputs and the latter is a false outputs. Data at the D inputs, meeting the setup and hold time requirements, are transferred to the Q outputs on positive going transitions of the clock (CK) input. When a high logic level is applied to the output control (OC) input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

#### **Features**

• High Speed Operation:  $t_{pd}$  (Clock to Q) = 18 ns typ ( $C_L = 50 \text{ pF}$ )

High Output Current: Fanout of 15 LSTTL Loads

• Wide Operating Voltage:  $V_{CC} = 2$  to 6 V

• Low Input Current: 1 μA max

• Low Quiescent Supply Current:  $I_{CC}$  (static) = 4  $\mu$ A max (Ta = 25°C)

#### **Function Table**

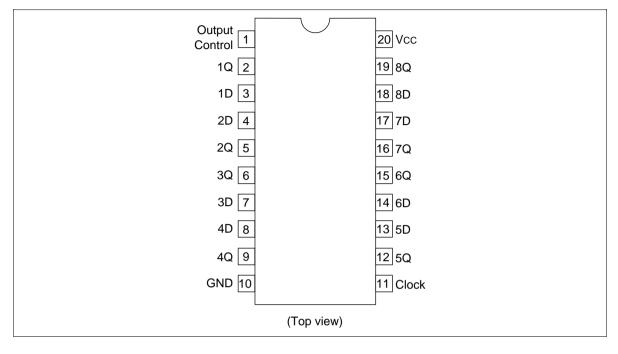
Output Control	Clock	D	HD74HC374 Q	HD74HC534 Q
L		Н	Н	L
L		L	L	Н
L	L	X	No change	No change
Н	X	Χ	Z	Z

X: irrelevant

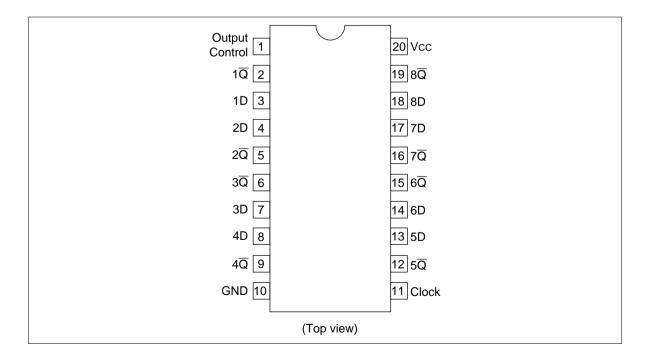
Z: off (high-impedance) state of a 3-state output.

#### **Pin Arrangement**

#### HD74HC374



#### **HD74HC534**



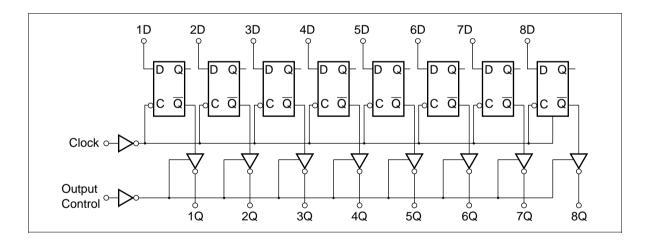
#### RENESAS

## **Absolute Maximum Ratings**

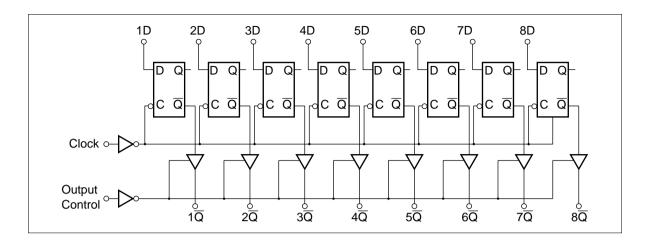
Item	Symbol	Rating	Unit	
Supply voltage range	V <sub>cc</sub>	-0.5 to +7.0	V	
Input voltage	V <sub>IN</sub>	$-0.5$ to $V_{cc}$ + 0.5	V	_
Output voltage	V <sub>OUT</sub>	$-0.5$ to $V_{cc} + 0.5$	V	
DC current drain per pin	I <sub>OUT</sub>	±35	mA	
DC current drain per V <sub>cc</sub> , GND	$I_{\rm CC},I_{\rm GND}$	±75	mA	_
DC input diode current	I <sub>IK</sub>	±20	mA	
DC output diode current	I <sub>ok</sub>	±20	mA	
Power Dissipation per package	P <sub>T</sub>	500	mW	
Storage temperature	Tstg	-65 to +150	°C	

## **Block Diagram**

#### HD74HC374



#### HD74HC534



#### **DC** Characteristics

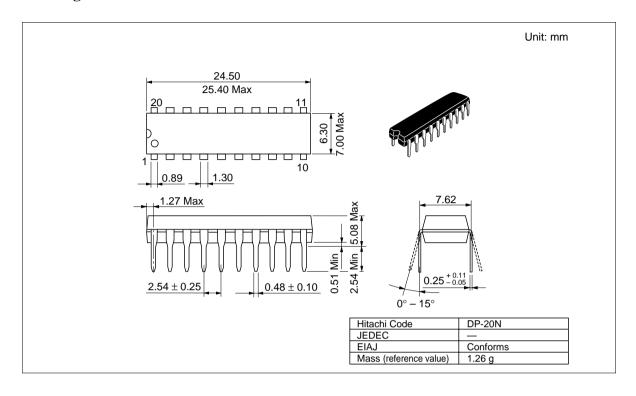
			Ta =	: 25°(	;	Ta = - +85°C	-40 to			
Item	Symbol	$V_{cc}$ (V)	Min	Тур	Max	Min	Max	Unit	Test Condition	ıs
Input voltage	$V_{IH}$	2.0	1.5	_	_	1.5	_	V		
		4.5	3.15	_	_	3.15	_			
		6.0	4.2	_	_	4.2	_	_		
	V <sub>IL</sub>	2.0	_	_	0.5	_	0.5	V		
		4.5	_	_	1.35	_	1.35	_		
		6.0	_	_	1.8	_	1.8	_		
Output voltage	V <sub>OH</sub>	2.0	1.9	2.0	_	1.9	_	V	$Vin = V_{IH} \text{ or } V_{IL}$	$I_{OH} = -20 \ \mu A$
		4.5	4.4	4.5	_	4.4	_	_		
		6.0	5.9	6.0	_	5.9	_	=		
		4.5	4.18	_	_	4.13	_	-		I <sub>OH</sub> = -6 mA
		6.0	5.68	_	_	5.63	_	=		$I_{OH} = -7.8 \text{ mA}$
	V <sub>OL</sub>	2.0	_	0.0	0.1	_	0.1	V	$Vin = V_{IH} \text{ or } V_{IL}$	I <sub>OL</sub> = 20 μA
		4.5	_	0.0	0.1	_	0.1	-		
		6.0	_	0.0	0.1	_	0.1	=		
		4.5	_	_	0.26	_	0.33	-		I <sub>OL</sub> = 6 mA
		6.0	_	_	0.26	_	0.33	-		I <sub>OL</sub> = 7.8 mA
Off-state output current	I <sub>oz</sub>	6.0	_	_	±0.5	_	±5.0	μΑ	$Vin = V_{IH} \text{ or } V_{IL},$ $Vout = V_{CC} \text{ or } G$	ND
Input current	lin	6.0	_	_	±0.1	_	±1.0	μΑ	Vin = V <sub>CC</sub> or GN	ID
Quiescent supply current	I <sub>cc</sub>	6.0	_	_	4.0	_	40	μΑ	$Vin = V_{CC} \text{ or } GN$	ID, lout = 0 μA

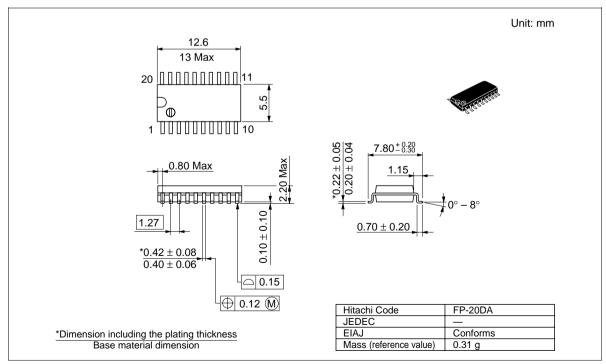
**AC Characteristics** ( $C_L = 50 \text{ pF}$ , Input  $t_r = t_f = 6 \text{ ns}$ )

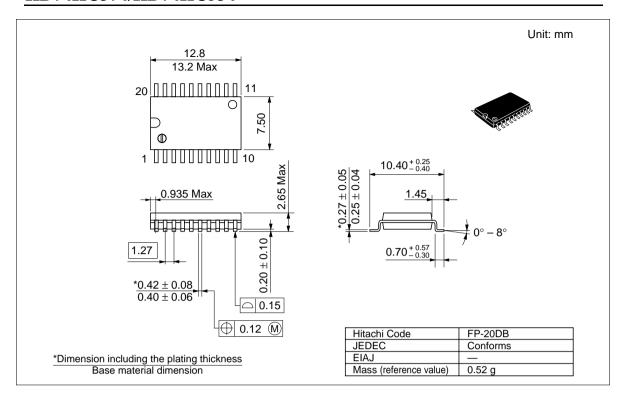
Ta = -40 to Ta =  $25^{\circ}$ C +85°C

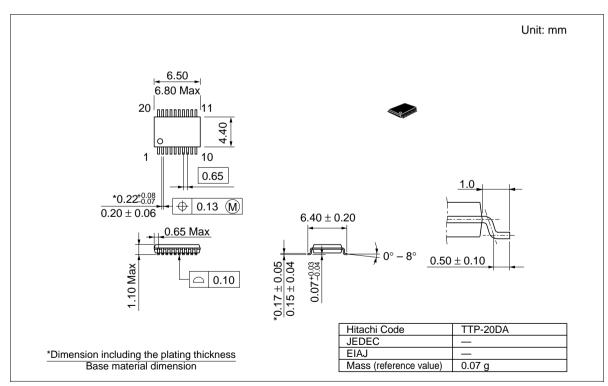
Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	f <sub>max</sub>	2.0	_	_	6	_	5	MHz	
frequency		4.5	_	_	30	_	24	_	
		6.0	_	_	35	_	28	_	
Propagation delay	t <sub>PHL</sub>	2.0	_	_	140	_	175	ns	
time	$t_{PLH}$	4.5	_	18	28	_	35	_	
		6.0	_	_	24	_	30	_	
Output enable	t <sub>zL</sub>	2.0	_	_	150	_	190	ns	
time		4.5	_	11	30	_	38	_	
		6.0	_	_	26	_	33	_	
	t <sub>zH</sub>	2.0	_	_	150	_	190	ns	
		4.5	_	14	30	_	38	_	
		6.0	_	_	26	_	33	_	
Output disable	t <sub>LZ</sub>	2.0	_	_	150	_	190	ns	
time		4.5	_	13	30	_	38	_	
		6.0	_	_	26	_	33	_	
	t <sub>HZ</sub>	2.0	_	_	150	_	190	ns	
		4.5	_	16	30	_	38	_	
		6.0	_	_	26	_	33	_	
Setup time	t <sub>su</sub>	2.0	100	_	_	125	_	ns	Data to Clock
		4.5	20	1	_	25	_	=	
		6.0	17	_	_	21	_	=	
Hold time	t <sub>h</sub>	2.0	25	_	_	31	_	ns	Clock to Data
		4.5	5	1	_	6	_	=	
		6.0	5	_	_	6	_	=	
Pulse width	t <sub>w</sub>	2.0	80	_	_	100	_	ns	Clock or Output control
		4.5	16	6	_	20	_	_	
		6.0	14	_	_	17	_	_	
Output rise/fall	t <sub>TLH</sub>	2.0	_	_	60	_	75	ns	
time	$t_{\text{THL}}$	4.5	_	4	12	_	15	_	
		6.0	_	_	10	_	13	_	
Input capacitance	Cin	_	_	5	10	_	10	pF	

#### **Package Dimensions**









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